

your BEST camera module partner

KLT-U1MA-OV5640-1B V1.0

5MP OmniVision OV5640-1B MIPI Interface Auto Focus Camera Module



Front View

Back View

www.Kai Tech.com

Specifications

Camera Module No. Con Resolution	KLT,U1MALOV5649-1BTV1.0 h			
Resolution	5MP			
Image Sensor	OV5640-1B			
Sensor Type	1/4"			
Pixel Size	1.4 um x 1.4 um			
EFL	3.29 mm			
F.NO	2.80			
Pixel	2592 x 1944			
View Angle	68.7°(DFOV) 58.1°(HFOV) 45.0°(VFOV)			
Lens Dimensions Tech con	₩ <u>8,50</u> % 8,50 x 5.67mmech.com			
Module Size	19.00 x 9.60 mm			
Module Type	Auto Focus			
Interface	MIPI			
Auto Focus VCM Driver IC	Embedded			
Lens Model	KLT-LENS-M5101			
Lens Type	650nm IR Cut			
Operating Temperature	-30°C to +70°C			
Mating Connector	AXT530124			

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5MP OmniVision OV5640-1B MIPI Interface Auto Focus Camera Module



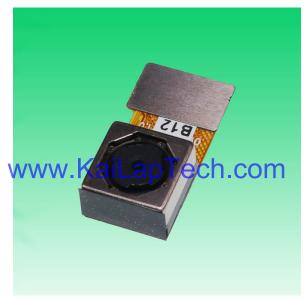
Top View

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Side View

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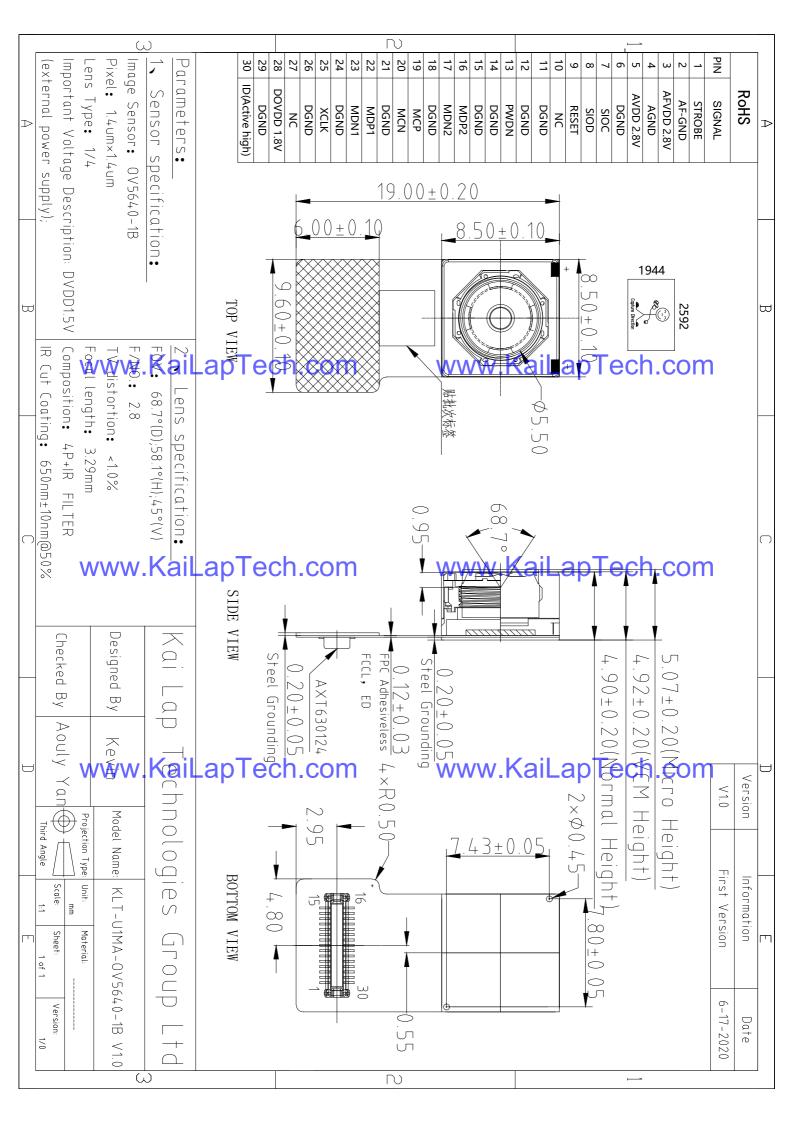


Bottom View



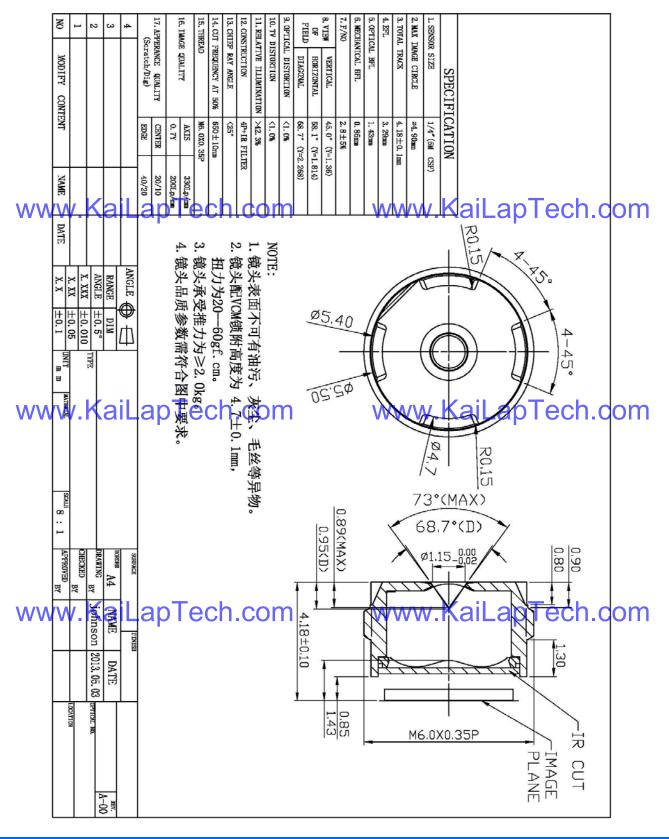
Mating Connector

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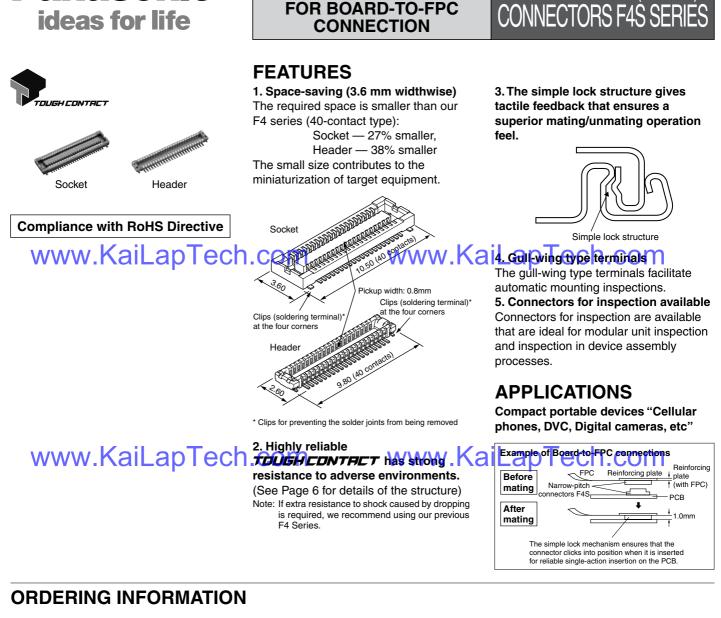


Lens Model: KLT-LENS-M5101



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NARROW PITCH (0.4 mm)



NARROW-PITCH, THIN

AND SLIM CONNECTOR FOR BOARD-TO-FPC

Panasonic

5: Narrow Pitch Connector F4S (0.4 mm pitch) Socket 6: Narrow Pitch Connector F4S (0.4 mm pitch) Header OM	www.KaiLapTech.com
Number of contacts (2 digits)	
Mated height <socket> 1: For mated height 1.0 mm 2: For mated height 1.2 mm <header> 1: For mated height 1.0 mm 2: For mated height 1.2 mm</header></socket>	
Functions <socket, header=""> 2: Without positioning bosses</socket,>	
Surface treatment (Contact portion / Terminal portion) <socket> 4: Base: Ni plating Surface: Au plating (for Ni barrier available) <header> 4: Base: Ni plating Surface: Au plating</header></socket>	
Note: Please note that models with a mated height of 1.0 mm (7th digit of part number	per is "1") and 1.2 mm (7th digit of part number is "2") are not compatible.

AXT5, 6 **PRODUCT TYPES** TOUGH CONTRET

lated height	Number of contacts	Part nu	umber	Packing		
lated neight	Number of contacts	Socket	Header	Inner carton	Outer carton	
	10	AXT510124	AXT610124			
	12	AXT512124	AXT612124			
	14	AXT514124	AXT614124			
	16	AXT516124	AXT616124			
	18	AXT518124	AXT618124			
	20	AXT520124	AXT620124			
	22	AXT522124	AXT622124			
	24	AXT524124	AXT624124			
	26	AXT526124	AXT626124			
	28	AXT528124	AXT628124			
	30	AXT530124	AXT630124			
	32	AXT532124	AXT632124			
1.0mm	34	AXT534124	AXT634124			
1.0mm	36	AXT536124	AXT636124			
	38	AXT538124	AXT638124			
	40	AXT540124	AXT640124	3,000 pieces	6,000 pieces	
	v.Kattap7	AXT542124	AXT642124	.KaiLapT	hch con	
	v.na4_api	CAXT544124	AXT644 424 VV VV	naiLapi		
	46	AXT546124	AXT646124			
	48	AXT548124	AXT648124			
	50	AXT550124	AXT650124			
	54	AXT554124	AXT654124			
	60	AXT560124	AXT660124			
	64	AXT564124	AXT664124			
	70	AXT570124	AXT670124			
	80	AXT580124	AXT680124			
	10	AXT510224	AXT610224			
	30	AXT530224	AXT630224			
1.2mm	40	AXT540224	AXT640224			
	50	AXT550224	AXT650224			
	80	AXT580224	AXT680224	KaiLapT		

Samples for mounting check: in 50-connector units. Please contact our sales office.

Samples: Small lot orders are possible. Please contact our sales office. 2. The above part numbers are for connectors without positioning bosses, which are standard. When ordering connectors with positioning bosses, please contact our sales office.

3. Please contact us for connectors having a number of contacts other than those listed above.

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SPECIFICATIONS

1. Characteristics

	Item	Specifications	Conditions	
	Rated current	0.3A/contact (Max. 5 A at total contacts)		
	Rated voltage	60V AC/DC		
Electrical	Breakdown voltage	150V AC for 1 min.	No short-circuiting or damage at a detection current of 1 m/ when the specified voltage is applied for one minute.	
	Insulation resistance	Min. 1,000MΩ (initial)	Using 250V DC megger (applied for 1 min.)	
	Contact resistance	Max. 90mΩ	Based on the contact resistance measurement method specified by JIS C 5402.	
	Composite insertion force	Max. 0.981N/contacts × contacts (initial)		
<i>N</i> echanical	Composite removal force	Min. 0.165N/contacts \times contacts		
characteristics	Contact holding force (Socket contact)	Min. 0.49N/contacts	Measuring the maximum force. As the contact is axially pull out.	
	Ambient temperature	–55°C to +85°C	No freezing at low temperatures. No dew condensation.	
	Soldering heat resistance	Peak temperature: 260°C or less (on the surface of the PC board around the connector terminals)	Infrared reflow soldering	
		300°C within 5 sec. 350°C within 3 sec.	Soldering iron	
	Storage temperature	-55° C to $+85^{\circ}$ C (product only) -40° C to $+50^{\circ}$ C (emboss packing)	No freezing at low temperatures. No dew condensation.	
Environmental characteristics	Thermal shock resistance (header and socket mated)	insulation resistance min. 100MΩ, contact resistance max. 90mΩ	Sequence 1 -55 °C, 30 minutes 2. ~, Max. 5 minutes 3. 85 °3 °C, 30 minutes 4. ~, Max. 5 minutes	
	Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100M Ω , contact resistance max. 90m Ω	Bath temperature 40±2°C, humidity 90 to 95% R.H.	
	Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100MΩ, contact resistance max. 90mΩ	Bath temperature 35±2°C, saltwater concentration 5±1%	
	H ₂ S resistance (header and socket mated)	48 hours, contact resistance max. 90m Ω	Bath temperature $40\pm2^{\circ}C$, gas concentration 3 ± 1 ppm, humidity 75 to 80% R.H.	
_ifetime characteristics	Insertion and removal life	50 times	Repeated insertion and removal speed of max. 200 times/ hours	
Jnit weight		20-contact type: Socket: 0.03 g Header: 0.01 g		

2. Material and surface treatment

2. Material	2. Material and surface treatment				
Partname	Material	apiech.com Vsuriase treatmentalLapiech.com			
Molded portion	LCP resin (UL94V-0)				
Contact and Post	Copper alloy	Contact portion: Base: Ni plating Surface: Au plating Terminal portion: Base: Ni plating Surface: Au plating (except the terminal tips) The socket terminals close to the portion to be soldered have nickel barriers (exposed nickel portions). Metal clips: Sockets: Base: Ni plating Surface: Pd+Au flash plating (except the terminal tips) Headers: Base: Ni plating Surface: Au plating (except the terminal tips)			

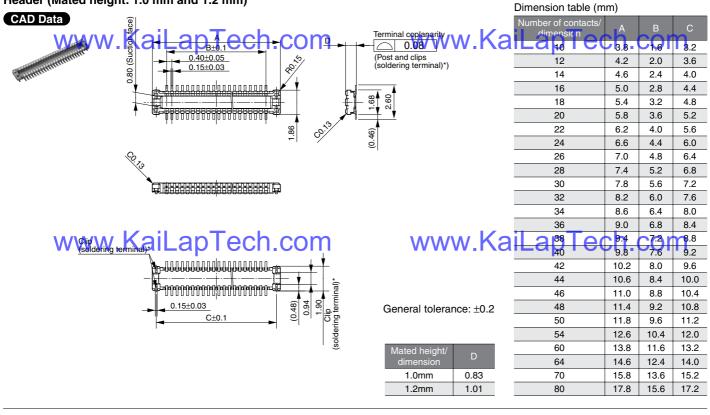
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AXT5, 6

DIMENSIONS (Unit: mm) The CAD data of the products with a **CAD Data** mark can be downloaded from: http://panasonic-electric-works.net/ac Socket (Mated height: 1.0 mm and 1.2 mm)

Socket (Maled height. 1.0 min and 1.2 min)			Dimension table (m	ım)		
CAD Data 0000005 0.15±0.03 0.15±0.03		coplanarity 0.08	Number of contacts/ dimension	A	В	С
.5 .5 .5 .5 .5 .5 .5 .5 .5 .5 .5 .5 .5		and clips	10	4.5	1.6	3.4
0.15±0.03	(Soldering	g terminal)*)	12	4.9	2.0	3.8
			14	5.3	2.4	4.2
			16	5.7	2.8	4.6
	3.60 2.36 -		18	6.1	3.2	5.0
	"i _ ∽i		20	6.5	3.6	5.4
	<u></u> •		22	6.9	4.0	5.8
	(0.62)		24	7.3	4.4	6.2
C0.15	0.0		26	7.7	4.8	6.6
			28	8.1	5.2	7.0
			30	8.5	5.6	7.4
			32	8.9	6.0	7.8
			34	9.3	6.4	8.2
			36	9.7	6.8	8.6
			38	10.1	7.2	9.0
MANA International antroph com	14/14/1	w.Ka	iLa ^{to} Teo	10.5	7.6	9.4
www.KailanTech.com		w.r\a		10.9		9.8
			44	11.3	8.4	10.2
			46	11.7	8.8	10.6
│	General tolerar	nce: ±0.2	48	12.1	9.2	11.0
			50	12.5	9.6	11.4
$ C \pm 0.1$ (1) (2) (3) $(3$			54	13.3	10.4	12.2
	Mated height/	D	60	14.5	11.6	13.4
	dimension		64	15.3	12.4	14.2
	1.0mm	0.97	70	16.5	13.6	15.4
Note: Since the clip (soldering terminal)* has a single-piece construction, sections Y and Z are electrically connected.	1.2mm	1.17	80	18.5	15.6	17.4
Header (Mated height: 1.0 mm and 1.2 mm)			Dimension table (m	m)		



• Socket and Header are mated





Mated height: 1.0 mm

Mated height: 1.2 mm



OV5640 5-megapixel product brief

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1/4-inch, 5-Megapixel SOC Image Sensor Optimized for High-Volume Mobile Markets

The OV564D detivers a complete 5 megapixel camera solution on a color images. To further improve camera performance and user single thip, aimed at offering cost efficiencies that serve the high- experience, the OV564D features arithternal anti-shake engine for volume autofocus (AF) camera phone market. The system-on-achip (SOC) sensor features OmniVision's 1.4 micron OmniBSI^{*} backside illumination architecture to deliver excellent pixel performance and best-in-class low-light sensitivity, while enabling ultra compact camera module designs of 8.5 mm x 8.5 mm with <6 mm z-height. The OV5640 provides the full functionality of a complete camera, including anti-shake technology, AF control, and MIPI while being easier to tune then two-chip solutions, making it an ideal choice in terms of cost, time-to-market and ease of platform integration.

The OV5640 enables 720p HD video at 60 frames per second (fps) and 1080p HD video at 30 fps with complete user control over formatting and output data transfer. The 720p/60 HD video is captured in full field of view (FOV) with 2 x 2 binning, which doubles the sensitivity and improves the signal-to-noise ratio (SNR). Additionally, a unique post-binning re-sampling filter function removes zigzag artifacts around slant edges and minimizes spatial artifacts to deliver even sharper, crisper

image stabilization, and it supports Scalado[™] tagging for faster image preview and zoom.

The OV5640 offers a digital video port (DVP) parallel interface and a high-speed dual lane MIPI interface, supporting multiple output formats. An integrated JPEG compression engine simplifies data transfer for bandwidth-limited interfaces. The sensor's automatic image control functions include automatic exposure control (AEC), automatic white balance (AWB), automatic band filter (ABF), 50/60 Hz automatic luminance detection, and automatic black level calibration (ABLC). The OV5640 delivers programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning. It also offers color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling to improve image quality.

Find out more at www.ovt.com.



applications

- cellular phones
- toys
- PC multimedia
- digital still cameras

features

1.4 µm x 1.4 µm pixel with OmniBST technology for .com

- high performance (high sensitivity, low crosstalk, low noise, improved quantum efficiency)
- optical size of 1/4"
- automatic image control functions: automatic exposure control (AEC), automatic white balance (AWB), automatic band filter (ABF), automatic 50/60 Hz luminance detection, and automatic black level calibration (ABLC)
- programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning
- image quality controls: color saturation, hue, gamma, sharpness (edge enhancement), lens correction defective pixel canceling, and noise canceling.
- support for output formats: RAW RGB, RGB565/555/444, CCIR656, YUV422/420, YCbCr422, and compression
- support for video or snapshot operations
- support for internal and external frame synchronization for frame exposure mode

ordering information

 OV05640-A71A-1B (color, lead-free) 71-pin CSP

support for LED and flash strobe mode

- support for horizontal and vertical sub-sampling, binning
- support for minimizing artifacts on binned image
- support for data compression output
- support for anti-shake
- standard serial SCCB interface
- digital video port (DVP) parallel output interface and dual lane MIPI output interface
- embedded 1.5V regulator for core power
- programmable I/O drive capability, I/O tri-state configurability

support for black sun cancellation support for images sizes. 5 megapixet, and any arbitrary size scaling down from 5 megapixel

- support for auto focus control (AFC) with embedded AF VCM driver
- embedded microcontroller
- suitable for module size of 8.5 x 8.5 x <6mm with both CSP and RW packaging

key specifications (typical)

- active array size: 2592 x 1944
- power supply: cole/1/425/4/.675/ with endeddeed to Ch.COmregulator) analog: 2.6 ~ 3.0V (2.8V typical) I/O: 1.8V / 2.8V
- power requirements: active: 140 mA standby: 20 µA
- temperature range: operating: -30°C to 70°C junction temperature (see table 8-2) stable image: 0°C to 50°C junction temperature (see table 8-2)
- output formats: 8-/10-bit RGB RAW output
- lens size: 1/4"
- lens chief ray angle: 24° (see figure 10-2)

input clock frequency: 6~27 MHz

max S/N ratio: 36 dB dynamic range/68 dB/@ 8 SamiLapTech.com

- maximum image transfer rate: QSXGA (2592x1944): 15 fps 1080p: 30 fps 1280x960: 45 fps 720p: 60 fps VGA (640x480): 90 fps
- sensitivity: 600 mV/Lux-sec
- shutter: rolling shutter / frame exposure
- maximum exposure interval: 1964 x t_{ROW}
- pixel size: 1.4 μm x 1.4 μm
- dark current: 8 mV/s @ 60°C junction temperature
- image area: 3673.6 μm x 2738.4 μm
- package dimensions: 5985 µm x 5835 µm





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Camera Module Pinout Definition Reference Chart

	ina Himax GalaxyCore PixArt SmartSens Sensors			
Pin Signal	Description			
DGND GND	ground for digital circuit			
AGND	ground for analog circuit			
PCLK DCK	DVP PCLK output			
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor			
MCLK XVCLK XCLK INCK	system input clock			
RESET RST	reset active low with internal pull-up resistor			
NC NULL	no connect			
SDA SIO_D SIOD	SCCB data			
SCL SIO_C SIOC	SCCB input clock			
VSYNC XVS FSYNC	DVP VSYNC output			
HRAFVXHKalLaplech.com	DVP HREF OUTPUTW, Kallap ech.con			
DOVDD	power for I/O circuit			
AFVDD	power for VCM circuit			
AVDD	power for analog circuit			
DVDD	power for digital circuit			
STROBE FSTROBE	strobe output			
FSIN	synchronize the VSYNC signal from the other sensor			
SID	SCCB last bit ID input			
ILPWM	mechanical shutter output indicator			
FREX	frame exposure / mechanical shutter			
GPIO	general purpose inputs			
SLASEL	I2C slave address select			
AFERW.KaiLapTech.com	CEN chip enable active high on CM driver O. CON			
MIPI Interface				
MDN0 DN0 MD0N DATA N DM01N	MIPI 1st data lane negative output			
MDP0 DP0 MD0P DATA P DM01P	MIPI 1st data lane positive output			
MDN1 DN1 MD1N DATA2 N DMO2N	MIPI 2nd data lane negative output			
MDP1 DP1 MD1P DATA2 P DMO2P	MIPI 2nd data lane positive output			
MDN2 DN2 MD2N DATA3 N DMO3N	MIPI 3rd data lane negative output			
MDP2 DP2 MD2P DATA3 P DMO3P	MIPI 3rd data lane positive output			
MDN3 DN3 MD3N DATA4 N DMO4N	MIPI 4th data lane negative output			
MDP3 DP3 MD3P DATA4 P DMO4P	MIPI 4th data lane positive output			
MCN CLKN CLK N DCKN	MIPI clock negative output			
MCP CLKP_MCP CLK P DCKN	MIPI clock positive output			
DVP/Parallel interface ECh.COM	www.KaiLapTech.con			
D0 D00 Y0	DVP data output port 0			
D1 D01 Y1	DVP data output port 1			
D2 D02 Y2	DVP data output port 2			
D3 D03 Y3	DVP data output port 3			
D4 D04 Y4	DVP data output port 4			
D5 D05 Y5	DVP data output port 5			
D6 D06 Y6	DVP data output port 6			
D7 D07 Y7	DVP data output port 7			
D8 D08 Y8	DVP data output port 8			
D9 D09 Y9	DVP data output port 6			
D10 D010 Y10	DVP data output port 10			
D11 D011 Y11	DVP data output port 10			

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Cameras Applications

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Camera Reliability Test

Reliability Inspection Item			Tooting Mathed	Accordance Oritaria	
Category		Item	Testing Method	Acceptance Criteria	
	Storage	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Temperature	Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Operation	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Temperature	Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation	
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation	
www.	KaiLapTe Thermal Shock	Chip 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	www.KaiLap	Tech.com No Abnormal Situation	
	Drop Test	Without Package 60cm	10 Times on Wood Floor	Electrically Functional	
	(Free Falling)	With Package 60cm	10 Times on Wood Floor	Electrically Functional	
		50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional	
Physical	Vibration Test	50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional	
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional	
WWW.	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	WWW.KaiLap	Electrically Functional	
	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional	
	ESD Test	Air Discharge 4 KV	ESD Testing Machine	Electrically Functional	
Electrical	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional	
www.	USB Connector	C On/Off 250 Times	W Plug and Unplug a p	Electrically Functional	



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Camera Inspection Standard

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Inspection		n Item	Inspection Method	Standard of Inspection	
Category		ltem	inspection method		
		Color	The Naked Eye	Major Difference is Not Allowed.	
	FPC/ PCB	Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
		Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Holder	Gap	The Naked Eye	Meet the Height Standard	
Appearance	riolder	Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
WW	w.KaiL	ap Transfer.con	ך The Naked אין The Naked	The Inside Crack Exposure is Not Atlowed	
		Scratch	The Naked Eye	No Effect On Resolution Standard	
	Long	Contamination	The Naked Eye	No Effect On Resolution Standard	
	Lens	Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
		No Communication	Test Board	Not Allowed	
		Bright Pixel	Black Board	Not Allowed In the Image Center	
		Dark Pixel	White board	Not Allowed In the Image Center	
WW	w.KaiL	ap recn.cor	The Naked Eye	Not Allowed ap recn.com	
		No Image	The Naked Eye	Not Allowed	
		Vertical Line	The Naked Eye	Not Allowed	
		Horizontal Line	The Naked Eye	Not Allowed	
Function Image		Light Leakage	The Naked Eye	Not Allowed	
		Blinking Image	The Naked Eye	Not Allowed	
		Bruise	Inspection Jig	Not Allowed	
WW	w.KaiL	ap Resolution con	n ^{Chart} WW	Follows Outgoing Inspection Chart Standard	
		Color	The Naked Eye	No Issue	
		Noise	The Naked Eye	Not Allowed	
		Corner Dark	The Naked Eye	Less Than 100px By 100px	
		Color Resolution	The Naked Eye	No Issue	
		Height	The Naked Eye	Follows Approval Data Sheet	
D:		Width	The Naked Eye	Follows Approval Data Sheet	
Dimer	ISION	Length	The Naked Eye	Follows Approval Data Sheet	
		Overall	The Naked Eye	Follows Approval Data Sheet	

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KLT Package Solutions

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KLT Camera Module

Tray with Grid and Space



Complete with Lens Protection Film



Place Cameras on the Tray



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Camera Modules Package Solution

Full Tray of Cameras



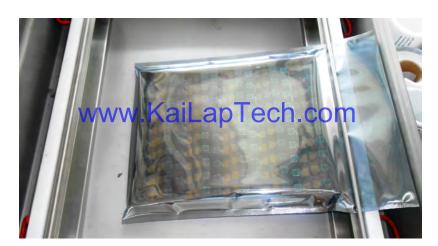
Put Tray into Anti-Static Bag

Cover Tray with Lid



Vacuum the Anti-Static Bag





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Camera Modules Package Solution

Sealed Vacuum Bag with Labels 1. Model and Description 2. Quantity 3. Shipping Date 4. Caution



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Large Order Package Solution

Place Foam Sheets Between Trays

Foam Sheets are Slightly Larger than Trays



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Place Foam Sheets and Trays into Box

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Foam Sheets are Tightly Fitting Box



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Small Order Package Solution

Place Foam Sheets and Trays into Small Box



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Package in Small Box for Shipment

Foam Sheets are Nicely Fitting the Small Box



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Place Small Boxes into Larger Box



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Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box



1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution



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Sample Order Package Solution

Place Sample into Small Anti-Static Bag



Place Connectors into Small Ant-Static Bag



Sample Labels on the Small Bag 1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution



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Connectors Large Order Package Solution

Connectors in a Wheel



The Wheel is Perfectly Fitting the Box

Label Connectors in the Wheel



Connectors Box Ready for Shipment



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Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, <u>www.KaiLapTech.com</u>. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all **Product(s)** that contain or develop material defects in materials/on/workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequential events.



KUT

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